BlackDiamond® X8

**HIGHLIGHTS**

- Enterprise Campus and Data Center aggregation/core, High Performance Computing, Big Data, Cloud Computing, Internet Exchange Point
- High density 1GbE, 10GbE, 40GbE and 100GbE switch for high consolidation
- 384 ports of 100/1000/10000MbE RJ45 or 1GbE RJ45/SFP per switch, 1,152 ports per rack
- 768 ports of 10GbE (SFP+ MSA compliant) per switch, 2,304 ports per rack
- 192 ports of 40GbE QSFP+ per switch, 576 ports per rack
- 32 ports of 100GbE CFP2 per switch, 96 ports per rack
- Low power consumption with 5.6 Watt per 10GbE
- Orthogonal architecture scalable from 1.28Tbps to 20.48Tbps switching capacity
- 2.3 µSec port-to-port latency across fabric, sub-µSec within a blade
- High-scale connectivity with up to 1 Million L2/L3 forwarding entries
- Powered by time-tested, modular ExtremeXOS® operating system with resilient and intelligent features
- Software Defined Networking (SDN) with OpenFlow and OneController™

Today’s cloud computing and data center deployments demand highly virtualized, converged and scalable infrastructure. Multi-tenant, content hosting drives the need for a simple yet highly virtualized network fabric, along with the need for expandability, performance, reliability and manageability. Extreme Networks’ open, standards-based Software Defined Architecture (SDA) coupled with advanced virtualization features in its Extensible Operating System (EXOS) and its extensible hardware fabric, creates a uniquely flexible and powerful basis for networks of any size. By taking advantage of best-in-breed hardware and software, customers can build open, orchestrated networks that not only fit any desired configuration but also integrate seamlessly with other standards-based networks and equipment. This results in networks that are simple, fast and smart. Extreme Networks’ BlackDiamond® X8 platform, provides seamless any-to-any connectivity at the hardware layer of SDA through a simple, scalable, and centrally orchestrated network.

Designed for the cloud-scale requirements for Enterprises, Data Centers, Cloud Computing, High Performance Computing (HPC), Big Data Analytics, and Internet Exchange Points (IXP), the BlackDiamond X8 provides a low-latency, high performance switch fabric with high-density connectivity solutions ranging from 100MbE to 100GbE, speeds, all in a compact footprint of one-third of a rack. Powered with advanced features the BlackDiamond X8 eliminates the use of expensive multi-tier architectures and the associated challenges of inter-device connectivity, up/downlink bandwidth, and latency. The BlackDiamond X8 also leverages a low-power design ideal for green operations and high degrees of energy efficiency, resulting in lower Total Cost of Ownership (TCO).
**Key Features/Benefits**

**“CLOUD-SCALE” SWITCHING**

The BlackDiamond X8 can provide 2.56Tbps to 20.48Tbps total switching capacity (and in between) for traffic growth while supporting 384 1GbE/768 10GbE /192 40GbE, or 32 100GbE wire-speed ports in a single chassis. This translates into 1,152 1GbE/2,304 10GbE/576 40GbE, or 96 100GbE ports in a single rack or any combination of those. The BlackDiamond X8 offers 160/320/480/640/960/1280 Gbps unidirectional bandwidth per slot options with current switch fabric modules making it highly extensible platform for all sizes of networks. The BlackDiamond X8 design leverages an orthogonal direct mating system between the interface and switch fabric modules, eliminating the performance bottlenecks of backplane or mid-plane designs. This provides the potential to further scale the total switching capacity with next generation fabric modules within the same system, prolonging investment protection.

**HIGH-DENSITY, HIGH-SCALE SERVER VIRTUALIZATION**

The BlackDiamond X8, powered by the ExtremeXOS® modular operating system, provides a scalable foundation for virtualized applications. By connecting up to 2 Million Virtual Machines (VM MAC) per system, the BlackDiamond X8 enables a highly virtualized network infrastructure.

ExtremeXOS runs on a high-performance control plane and helps simplify network deployment and operation through VM-ready capabilities such as ExtremeXOS Network Virtualization (XNV™) and Extreme Networks Direct Attach™. XNV allows auto-configuration of Virtual Port Profiles (VPP) to automatically detect and provision network policies in a virtualized data center in a hypervisor agnostic manner, providing simplicity in managing VM mobility in data-centers.

Advanced virtualization and overlay features such as Shortest Path Bridging (SPB)* and transit Virtual eXtensible LAN (VXLAN)* tunneling, Virtual Private LAN System (VPLS) and Multi-Chassis Link Aggregation Group (MLAG), and Virtual Router Redundancy Protocol (VRRP) enable an active/active data center design for the most demanding cloud businesses. (*Roadmap)

**RELIABLE DELIVERY OF CONVERGED STORAGE TRAFFIC**

The BlackDiamond X8 is an optimal solution for high-throughput storage applications, synchronous replication, and disaster recovery within data center, Big Data and HPC environments. The BlackDiamond X8 supports IEEE Data Center Bridging (DCBx) for reliable delivery of IP storage (iSCSI, NFS, GPFS, CIFS) traffic over a single converged network. With IEEE-compliant lossless Ethernet implementation of Priority Flow Control (PFC) and Enhanced Transmission Selection (ETS), storage traffic can be prioritized, queued and bandwidth guaranteed.

For backward compatibility, the BlackDiamond X8 also supports transit Fiber Channel over Ethernet (FCoE) for carrying converged fiber channel storage traffic in converged networks, using wire-speed 10GbE or 40GbE IO, providing reliable storage services.

**LOW LATENCY FOR FASTER RESPONSE TIME**

For low-latency applications such as High Performance Computing (HPC) or Big Data Analytics, the BlackDiamond X8 provides only 2.3 microsecond port-to-port latency from any (non-XL) IO module to any IO module with a single-tier, and under 3 microsecond latency with a two-tier fabric using Extreme Networks Summit® X770 series Top-of-Rack switch with the BlackDiamond X8. Latency is less than a microsecond between the ports on the same IO module.

With the growth of mobile devices, an increasing number of applications are hosted in data centers, resulting in increased east-west and north-south traffic. Though total latency is a result of the compute, storage and transmission latencies, the BlackDiamond X8 can deliver the benefits of lower network latency to improve customer experiences and overall application response time, while maximizing transactional revenue per unit time.

**ORCHESTRATION THROUGH SOFTWARE DEFINED ARCHITECTURE**

The BlackDiamond X8 powers the data plane hardware layer of Extreme Networks’ Software Defined Architecture (SDA) with highly extensible, scalable and programmable hardware. Coupled with advanced virtualization features in its Extensible Operating System (EXOS), One Controller™ and Software Defined Networking (SDN), flexible network architectures of any size can be defined.

The BlackDiamond X8 supports standard-based Open Flow to work with third party and open source SDN controllers and provides a complete SDN solution. The BlackDiamond X8 enables SDN by providing a programmable control path and a scalable fabric that can be programmed in an efficient manner. Additionally, the BlackDiamond X8 supports the Open Stack plugin for cloud-level integration.

The BlackDiamond X8 can be leveraged in hybrid networks for simultaneous SDN and non-SDN based deployments. Off-the-shelf or home-grown SDN based applications can be used for network control, traffic engineering, quality of service, SLA management, monitoring, analytics, virtualization and other advanced implementations.
HIGH SCALE ROUTING

The BlackDiamond X8 supports two types of interface modules for advanced L2 and L3/MPLS oriented networks: the “Non-XL” modules for high-density, low-latency moderate-scale edge/aggregation and core applications, and the “XL” modules for the high-scale aggregation/core or border applications. By supporting up to 1 Million Layer 2/ Layer 3 entries on its 40/10GbE and 100/10GbE XL-series modules, and large tables sizes for storing IPv4/IPv6 prefixes and MPLS labels, the BlackDiamond X8 eliminates the need for costly traditional routers. Enterprise grade routing protocols including BGP and MPLS are supported for Internet connectivity. XL-series modules can also be deployed for the high-scale edge/aggregation applications where large numbers of host routes or access control lists (ACL) or multicast entries are required, such as managed hosting and cloud.

In enterprise and data centers, the XL and non-XL modules can be deployed together within the same switch without impacting one another - not only collapsing the tiers, but also reducing capex and opex.

RELIABILITY AND SERVICE ASSURANCE

Today’s mission critical data centers and service provider networks cannot afford service blackouts and upset customers. Designed for Tier-3 and 4 data centers and Tier-3 and 2 service providers, the BlackDiamond X8 prevents any single point of failure at the hardware level through isolated control and data planes, fully redundant 1+1 management modules, N+1 redundant switching fabric, and N+1 redundant fans. For the power system, the BlackDiamond X8 offers N+1 power supply level and N+N power grid level redundancy.

At the software level, modular ExtremeXOS software increases network availability by monitoring independent processes in real time. If any of these processes become unresponsive or stop running they can be automatically restarted without impacting other processes. The BlackDiamond X8 supports a set of resiliency and fault-tolerant features, such as patch level In-Service Software Upgrades (ISSU), Multi-Chassis Link Aggregation (M-LAG), Virtual Router Redundancy Protocol (VRRP), and Ethernet Automatic Protection Switching (EAPS).

LOWER OPERATING COSTS, BETTER BUSINESS MARGINS

The BlackDiamond X8 is designed for power cooling and space efficiency. Power consumption as low as 5.6 Watts per 10GbE port is enabled through an obstruction-less orthogonal design and variable speed fans that assist in rapid heat dissipation and more efficient use of data center cooling resources. This results in lower utility bills. The high density design of the BlackDiamond reduces rack space requirements, providing fast return on investment per RU and per port. Through advanced manageability and automation tools, the BlackDiamond X8 reduces the need for staffing and reduces the training learning curve, reducing the total cost of ownership.
Applications

SCALABLE DATA CENTER CORE/SPINE

The BlackDiamond X8 is designed for tier 1 through 4 enterprise, multi-tenant and cloud data center core and border deployments. In these applications, the BlackDiamond X8 can be used with XL and non-XL series modules to provide a mix of high- and modest-scale connectivity in a spine-leaf architecture. The non-XL series modules provide 10GbE and 40GbE downlink connectivity for leaf switches such as the Extreme Network Summit X670 and X770, while the XL series modules provide a high-scale 10GbE, 40GbE and 100GbE solution for inter-DC, disaster recovery, or cloud/internet connectivity. A pair of BlackDiamond X8 switches connected through M-LAG provides a robust and scalable core solution. Virtualization features such as Virtual Routers (VR), MPLS, VXLAN (transit) and SPB-M provide traffic isolation and VM mobility between the Active/Active data centers while the overall network can be orchestrated using Software Defined Architecture components.

EXPANDABLE DATA CENTER EDGE

For high-density, high-throughput environments such as hosted data centers and digital media, the BlackDiamond X8 provides wire-speed 1GbE, 10Gb and 40 GbE server and storage connectivity as an end-of-row/middle-of-row aggregation solution. This enables seamless 1GbE to 10GbE server migration using BlackDiamond X8 10GbE copper or fiber modules with regular or LAN on Motherboard (LoM) based servers. Edge oversubscription can be controlled through the number of fabric modules populated per system. The BlackDiamond X8 is connected to the core using 40GbE or 100GbE uplinks. Features such as VEPA, Port Isolation, MLAG, SPB and VXLAN(transit) play key role in building a scalable flat network with convergence features like DCBx and FCoE for storage connectivity while SDN helps to orchestrate the networks end to end.

HIGH PERFORMANCE COMPUTE CLUSTER

In High Performance Computing and Super Computing, where large numbers of compute nodes and storage need to be connected using low-latency 10 and 40GbE, the BlackDiamond X8 provides high-density, low-latency access and back-end connectivity. On the access side, BlackDiamond X8 or Summit X770 series low-latency compact switches can provide 10GbE or 40GbE connectivity to connect compute nodes within the cluster. On the back-end, the BlackDiamond X8 can provide a 2-way or 4-way ECMP high-performance, low-latency HPC core for future cluster expansions, while running multi-100G bandwidth between clusters.
RESILIENT CAMPUS BACKBONE
As mobility, BYOD (bring your own device), video and collaboration applications demand more bandwidth on the campus edge, this puts back pressure on a more scalable and higher performance campus core. For large enterprises with more than one campus, connectivity to other regional offices as well as the enterprise data center requires a very resilient backbone. The BlackDiamond X8 can provide a resilient backbone ring based on 10GbE, 40GbE or 100GbE and the time-tested EAPS (Extreme Automatic Protection Service) protocol. Optionally, MPLS could be used on top of the resilient backbone and for the Internet connectivity. Multicasts and QoS features enable collaboration services aggregation through the backbone with BGP/MPLS.

VIRTUALIZED INTERNET EXCHANGE POINT
The BlackDiamond X8 offers a great solution for Internet Exchange Points (IXP) due to its density and performance. The IXP can use BlackDiamond X8 to provision 10GbE and 100GbE ports on the customer edge and can use the same 10GbE or 100GbE in the core as well. The BlackDiamond X8 supports long-range optics on both 10GbE and 100GbE to provide flexible customer connectivity options. An IXP can use the BlackDiamond X8 to provision 10GbE and 100GbE services on the customer edge and can consolidate bandwidth with 100GbE links in the core. In addition, features such as MPLS VPLS, LSP load share, Selective VLAN, VLAN Bridging/Isolation and SPB provide capabilities to virtualize the IXP network for flexible virtual services delivery.

SERVICE PROVIDER AGGREGATION OFFLOAD
Service Providers face a major challenge. As Internet traffic continues to grow exponentially, the majority of it remains best-effort IP traffic such as consumer video. This does not justify investments put into expensive MPLS and router-based edge and core network tiers, which results in high cost per Megabit. Moreover, conventional routers do not scale cost-effectively when it comes to port density and cost. Advanced and high-performance routing-switches like the BlackDiamond X8 can help service providers by building a high-density aggregation layer to terminate more 10GbE ports, which allows them to be consolidated over fewer 40GbE or 100GbE ports toward the PE router. The BlackDiamond X8 can serve as a L2, L3 or MPLS extension point. As a result, this offloads the PE routers and prolongs the investments made in the core while lowering the cost/Mb.
## Technical Specifications**

<table>
<thead>
<tr>
<th>COMPONENT</th>
<th>DESCRIPTION</th>
<th>DIMENSIONS</th>
<th>WEIGHT</th>
</tr>
</thead>
</table>
| **Base System (48001)** | • 14.5 RU Chassis with 2 Management slots, 8 IO slots, 4 Fabric slots and 8 Power Supply slots  
• Includes 5 Fan Trays (for Front to Back airflow)  
• Does not include Management, Fabric, IO, Blank modules or Power Supplies | Height 25 in  
Width 18 in  
Depth 30 in  
Length 14.5 RU | Regular 85 Kg  
Loaded 190.7 Kg |
| **Management Module (48021)** | • 2 Management Modules for 1+1 control plane redundancy  
• Minimum 1 required | Height 3 in  
Width 8 in  
Depth 18 in  
Length 4.8 cm  
45.4 cm  
45.7 cm | Regular 2.5 Kg  
Loaded 5.5 lb |
| **48-Port 10GbE Copper Interface Module (48040)** | • 8 Interface Modules maximum  
• Maximum 384 10GbE wire-speed ports per system  
• Supports 100/1000/10000 MBit (10GBaseT) RJ45 auto-negotiation over Cat6a/7 cabling  
• Suited for high-density edge/aggregation applications | Height 1.9 in  
Width 17.9 in  
Depth 16.5 in  
Length 4.8 cm  
45.4 cm  
41.9 cm | Regular 5 Kg  
Loaded 11.1 lb |
| **48-Port 10GbE Fiber Interface Module (48041)** | • 8 Interface Modules maximum  
• Maximum 384 10GbE wire-speed ports per system  
• Supports 1/10GbE SFP/SFP+ with SR/LR/ER/ZR optics and cables  
• Suited for high-density, low-latency edge/aggregation/core applications | Height 3 in  
Width 17 in  
Depth 18 in  
Length 7.6 cm  
43.1 cm  
45.7 cm | Regular 5 Kg  
Loaded 11.1 lb |
| **12-Port 40GbE Fiber Interface Module (48046)** | • 8 Interface Modules maximum  
• Maximum 192 40GbE or 768 10GbE wire-speed ports per system  
• Supports 40GbE QSFP+ with SR4/LR4 optics and cables  
• Suited for high-density, low-latency edge/aggregation/core applications | Height 3 in  
Width 17 in  
Depth 18 in  
Length 7.6 cm  
43.1 cm  
45.7 cm | Regular 5 Kg  
Loaded 11.1 lb |
| **24-Port 40GbE Fiber Interface Module (48051)** | • 8 Interface Modules maximum  
• Maximum 384 40GbE or 384 10GbE wire-speed ports per system  
• Supports 40GbE QSFP+ with SR4/LR4 optics and cables  
• Suited for high-density, low-latency edge/aggregation/core applications | Height 3 in  
Width 17 in  
Depth 18 in  
Length 7.6 cm  
43.1 cm  
45.7 cm | Regular 5 Kg  
Loaded 11.1 lb |
| **4-Port 100GbE Fiber Interface Module (48061)** | • 8 Interface Modules maximum  
• Maximum 32 100GbE or 320 10GbE wire-speed ports per system  
• Supports 100GbE CFP2 with SR10/LR4 optics and cables  
• Suited for high-bandwidth aggregation/core applications | Height 2.3 in  
Width 16.5 in  
Depth 18.5 in  
Length 5.8 cm  
41.9 cm  
46.9 cm | Regular 6.6 Kg  
Loaded 14.6 lb |
| **12-Port 40GbE “XL” Fiber Interface Module** | • 8 Interface Modules maximum  
• Maximum 96 40GbE or 384 10GbE wire-speed ports per system  
• Supports 40GbE QSFP+ with SR4/LR4 optics and cables  
• Large TCAM for up to 1 Million L2/L3/MPLS forwarding entries  
• Suited for high-scale aggregation/core/border applications | Height 3 in  
Width 17 in  
Depth 18.5 in  
Length 7.6 cm  
43.1 cm  
45.7 cm | Regular 7.6 Kg  
Loaded 16.9 lb |
| **IO-Blank Panel (48018)** | • 8 Blank Panels maximum  
• Required for the IO and Switch Fabric Modules to maintain proper airflow for cooling. If not present, the modules may overheat and shut-down. | Height 2.3 in  
Width 16.5 in  
Depth 17.7 in  
Length 5.8 cm  
41.9 cm  
44.9 cm | Regular 2.1 Kg  
Loaded 4.8 lb |
## BlackDiamond X8 Series

### GENERAL SPECIFICATIONS

#### PERFORMANCE
- 2.56 Tbps to 20.48 Tbps data switching capacity options
- Up to 11.4 billion packets per second (BPPS) forwarding throughput using the I/O modules available today, and up to 15.2 BPPS of fabric throughput
- Cut-Through and Store-and-Forward switching support
- 2.3 micro-second port-to-port latency (64-byte packet) across fabric, sub 1.5 micro-second within (non-XL) I/O module

#### DENSITY
- 100 MbE Port Density:
  - 384 wire-speed 100BASE-T/X RJ45/SFP ports using 48-port 1 or 10 GbE I/O modules
- 1 GbE Port Density:
  - 384 wire-speed 1GBASE-T/X RJ45/SFP ports using 48-port 1 or 10GbE I/O modules
- 10 GbE Port Density:
  - 768 wire-speed 10GBASE-X (SFP+ MSA compliant) ports using 24-port 40 GbE I/O module
  - 384 wire-speed 10GBASE-X SFP+ ports using 48-port 10 GbE or 12-port 40 GbE I/O modules (SFP+ MSA compliant)

### CPU, MEMORY
- Intel i7 Dual Core 2GHz
- 2GB ECC DDR3 SDRAM
- 1GB Compact Flash

### LED INDICATORS
- Per port status LED for link/packet activity
- Per port status LED for link/packet activity for breakout (40/100GbE)
- System Status LEDs: management, fan, fabric and interface

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<tbody>
<tr>
<td>2.56 Tbps (10T) Switch Fabric Module (48032)</td>
<td>Provides 160Gbps per slot (unidirectional) bandwidth per SFM</td>
<td>20 in 50.8 cm, 3 in 7.6 cm, 10 in 25.4 cm</td>
<td>4.1 Kg 9.2 lb</td>
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<td></td>
<td>A SFM total for 10.24Tbps capacity (must be of same type)</td>
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<td></td>
<td>Minimum 3 required for wire-speed across all ports 4th SFM required for N+1 redundancy (except for GbE IO)</td>
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<tr>
<td></td>
<td>Optionally, 3:1 oversubscription across all IO with 1 SFM and 3:2 oversubscription with 2 SFM</td>
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<td></td>
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<tr>
<td></td>
<td>Supports all IO modules except 24x40GbE module</td>
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<tbody>
<tr>
<td>5.12 Tbps (20T) Switch Fabric Module (48031)</td>
<td>Provides 320Gbps per slot (unidirectional) bandwidth per SFM</td>
<td>20 in 50.8 cm, 3 in 7.6 cm, 10 in 25.4 cm</td>
<td>4.1 Kg 9.2 lb</td>
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<tr>
<td></td>
<td>A SFM total for 20.48Tbps capacity (must be of same type)</td>
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<td></td>
<td>Minimum 3 required for wire-speed across all ports 4th SFM required for N+1 redundancy (except for GbE IO)</td>
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<tr>
<td></td>
<td>Optionally, 3:1 oversubscription across all IO with 1 SFM and 3:2 oversubscription with 2 SFM</td>
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<tr>
<td></td>
<td>Supports all IO modules</td>
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<th>WEIGHT</th>
</tr>
</thead>
<tbody>
<tr>
<td>Fan Tray-Spare (48015)</td>
<td>Front to Back airflow</td>
<td>24 in 60.9 cm, 4 in 10.1 cm, 3 in 7.6 cm</td>
<td>2.8 Kg 6.2 lb</td>
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<tr>
<td></td>
<td>5 Fan Trays total (with 6 (N+1) Fans per tray)</td>
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<tr>
<td></td>
<td>All 5 trays required (and included with the base system)</td>
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<th>DIMENSIONS</th>
<th>WEIGHT</th>
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</thead>
<tbody>
<tr>
<td>2500 Watt AC Power Supply (48011)</td>
<td>8 Power Supplies total split across 2 bays (for circuit level redundancy)</td>
<td>1.5 in 3.8 cm, 4.2 in 10.6 cm, 14.5 in 36.8 cm</td>
<td>2.4 Kg 5.3 lb</td>
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<tr>
<td></td>
<td>2500 Watt with 220V, 1250 Watt with 110V</td>
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<td></td>
<td>N+1 and N+N level power redundancy (depending on the configuration) – per Power Calculator</td>
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</tr>
</tbody>
</table>

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![BlackDiamond X8 Series Image]
## SCALE

Two tiers of scale options using non-XL and XL modules:

<table>
<thead>
<tr>
<th>PARAMETERS</th>
<th>10/40GBE MODULES</th>
<th>100GBE MODULES</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>NON-XL</td>
<td>NON-XL</td>
</tr>
<tr>
<td>Largest Frame</td>
<td>9216 Bytes</td>
<td>4,094</td>
</tr>
<tr>
<td>VLAN</td>
<td>12K</td>
<td>384K</td>
</tr>
<tr>
<td>MAC Forwarding</td>
<td>16K</td>
<td>130K</td>
</tr>
<tr>
<td>IPv4 Host</td>
<td>16K</td>
<td>16K</td>
</tr>
<tr>
<td>IPv4 LPM</td>
<td>6K</td>
<td>64K</td>
</tr>
<tr>
<td>IPv6 Host</td>
<td>8K</td>
<td>8K</td>
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<tr>
<td>IPv6 LPM</td>
<td>6K</td>
<td>64K</td>
</tr>
<tr>
<td>IPv4 Multicast</td>
<td>3K</td>
<td>8K</td>
</tr>
<tr>
<td>IPv6 Multicast</td>
<td>8K</td>
<td>16K</td>
</tr>
<tr>
<td>MPLS Forwarding</td>
<td>2K</td>
<td>8K</td>
</tr>
<tr>
<td>LAG Groups</td>
<td>384K</td>
<td>64K</td>
</tr>
<tr>
<td>LAG Members</td>
<td>64K</td>
<td>64K</td>
</tr>
<tr>
<td>QoS Queues/Port</td>
<td>8QP</td>
<td>8QP</td>
</tr>
<tr>
<td>Rate Limiting Granularity</td>
<td>8Kbps-1Mbps</td>
<td>Ingress and egress bandwidth policing/rate limiting per flow/ACL</td>
</tr>
</tbody>
</table>

modules and power supplies

### OPERATING SPECIFICATIONS

- Operating Temperature Range: 0° C to 40° C (32° F to 104° F)
- Operating Humidity: 10% to 95% relative humidity, non-condensing
- Operational Altitude: UL/CB Certified to 2000m (6,561 ft). Tested to 4000m (13,000 ft) per NEBS GR-64, Issue 3, 04-12 [76].
- Operational Shock: 30 m/s² (3g), 11ms, 60 Shocks
- Operational Random Vibration: 3-500MHz @ 1.5g rms

### PACKAGING AND STORAGE SPECIFICATIONS

- Storage/Transportation Temperature: -40° C to 70° C (-40° F to 158° F)
- Storage and Transportation Humidity: 10% to 93% RH
- Packaged Shock (Half Sine):
  - < 50 kg 180 m/s² (10 g), 6 ms, 600 shocks, modules
  - > 50 kg 100 m/s² (6 g), 11 ms, 600 shocks, chassis
- Packaged Sine Vibration: 5-62 Hz @ Velocity 5mm/s, 62-500 Hz @ 0.2G
- Packaged Random Vibration: 5-20Hz @ ASD=1.0 & 20-200Hz @-3dB/octave
- Packaged drop height
  - @ 39.5” <22 lb (10 kg) modules

• @ 11.8” <110 lb (50 kg) chassis

### REGULATORY/SAFETY

#### North American Safety

- cULus 60950-1:2007 2nd Ed., Listed Device (U.S.)
- CSA 22.2#60950-1-07 2nd Ed. 2011-12(Canada)
- CSA 22.2#60950-1-03 1st Ed. 2006-07(Canada)
- Complies with FCC 21CFR Chapter1, Subchapter J (U.S. Laser Safety)
- CDRH Letter of Approval (U.S. FDA Approval)

#### EUROPEAN SAFETY

- CB Scheme, IEC 60950-1:2005+National Deviations
- EN 60825-1:2007 (Lasers Safety)
- 206/95/EC Low Voltage Directive

#### INTERNATIONAL SAFETY

- Taiwan CNS 14336-1(2010) (BSMI)
- AS/NZS 60950-1 (Australia/New Zealand)

#### EMI/EMC STANDARDS

#### North American EMC Standards

- FCC CFR 47 part 15 Class A (U.S.)
European EMC Standards
- EN 55022:2010 Class A
- EN 55024:2010 Class A
- EN 61000-3-2:2006+A2:2009 (Harmonics)
- EN 61000-3-3:2008 (Flicker)
- EN 61000-6-2:2005 (Immunity for Industrial, Scientific & Medical)
- ICES-003 Class A (Canada)
- EN 55022:2010 Class A
- EN 55024:2010 Class A
- EN 61000-3-2:2006+A2:2009 (Harmonics)
- EN 61000-3-3:2008 (Flicker)
- EN 61000-6-2:2005 (Immunity for Industrial, Scientific & Medical)
- ICES-003 Class A (Canada)
- EN 55022:2010 Class A
- EN 55024:2010 Class A
- EN 61000-3-2:2006+A2:2009 (Harmonics)
- EN 61000-3-3:2008 (Flicker)
- EN 61000-6-2:2005 (Immunity for Industrial, Scientific & Medical)
- International EMC Certifications
  - CISPR 22:2010), Class A (International Emissions)
  - CISPR 24:2010 Class A (International Immunity)
  - IEC 61000-4-2:2008 Electrostatic Discharge, 8kV Contact, 15kV Air, Criteria A
  - IEC 61000-4-3:2010 Radiated Immunity 20V/m, Criteria A
  - IEC 61000-4-4:2012 Transient Burst, 1kV, Criteria A
  - IEC 61000-4-5 2005 Surge, 2kV, 4kV, Criteria A
  - IEC 61000-4-6:2008 Conducted Immunity, 0.15-80MHz, 10V/m unmod. RMS, Criteria A
  - IEC 61000-4-11:2004 Power Dips & Interruptions, >30%, 25 periods, Criteria C
Country Specific
- Japan Class A (VCCI)
- Australia/New Zealand, RCM
- Taiwan EMC CNS 13438(95) Class A, Safety CNS 14336-1(2010) (BSMI)
  - Brazil Res. 442, Category 3 (ANATEL)
  - China, complex equipment exemption (CCC)
- Mexico (via NRTL Listing)
- South Korea KN22, KN24 (KCC)
- ETSI EN 300 386 v1.6.1 (2012-09) EMC Telecommunications
- TE100EN300019 (Environmental for Telecommunications)
- IEEE 802.3 MEDIA ACCESS STANDARDS
  - IEEE 802.3z 1000BASE-X
  - IEEE 802.3ae 10GBASE-X
  - IEEE 802.3ba 40GBASE-X
  - IEEE 802.3ac VLAN Tag
  - IEEE 802.3ad Link Aggregation
- TELECOMMUNICATION STANDARDS
  - ETSI EN 300 386 v1.6.1 (2012-09) EMC Telecommunications
- TELCOMMUNICATION STANDARDS
  - ETSI EN 300 386 v1.6.1 (2012-09) EMC Telecommunications
- FAN AND ACOUSTIC NOISE
  - Sound pressure for comparison to legacy standards per ISO 7779:2010(E)
    - Low Speed: 60.3 dB(A) (LpA)
    - Medium Speed: 66.0 dB(A) (LpA)
    - High Speed: 82.3 dB(A) (LpA)
  - Sound power per ISO 7779:2010(E), ISO 3744:2010(E), ETSI/EN 300 753:2007(E)
    - Low Speed: 72.0 dB(A) (LWAm)
    - Medium Speed: 78.0 dB(A) (LWAm)
    - High Speed: 94.4 dB(A) (LWAm)
  - Declared sound power per 300 753:2011-11) via ISO 9296:2010 &
    - Low Speed: 7.5 bels (LWAd)
    - Medium Speed: 8.1 bels (LWAd)
    - High Speed: 9.7 bels (LWAd)
- WARRANTY
  - Ltd. 1-Year on Hardware
  - 90-Days on Software
  - For Warranty Details, Visit:
Power Specifications

POWER SUPPLY

- Rated Inputs:
  - Low Range: 100-120VAC, 60/50 Hz, 13 A max each power supply
  - High Range: 200-240VAC, 60/50 Hz, 13 A max each power supply
- Input Ranges:
  - Low Range: 90 - 132VAC, 47 - 63 Hz
  - High Range: 185 - 264VAC, 47 - 63 Hz
- Power supply input socket IEC 320 C20
- Power cord input plug IEC 320 C19
- Power cord-sets up to 2m (6.5ft) length require minimum 16 AWG (1.0 mm2) copper stranded wire. Power cord-sets greater than 2m (6.5ft) length require minimum 14 AWG (1.25 mm2) copper stranded wire. (The power supply cord-set wall plug must be appropriately rated and approved for the country of installation)
- Efficiency 90% typical at full load
- DC voltage output range: 47.5 to 48.5 Vdc
- Nominal DC output:
  - Low Range: 48 Vdc, 25 A maximum each PSU
  - High Range: 48 Vdc, 50 A maximum each PSU
- DC output power:
  - 2500W @ high range for one PSU (See manual for more than one PS)
  - 1250W @ low range for one PSU (See manual for more than one PS)

POWER CONSUMPTION

- Worst case power consumption (including worst case optics) and heat load (With 10Tbps SFM):
  - 8,220 Watt at output of power supplies
  - 9,206 Watt at input of power supplies
  - 31,421 BTU/Hour total heat load
- Worst case power consumption (including worst case optics) and thermal (With 20Tbps SFM):
  - 8,460 Watt at output of power supplies
  - 9,475 Watt at input of power supplies
  - 32,338 BTU/Hour total heat load

EXTREMEXOS SUPPORTED PROTOCOLS
The BlackDiamond X8 switch supports ExtremeXOS version 15.1 or later. Supported protocols and features can be reviewed in the latest ExtremeXOS Data Sheet.

EXTREMEXOS SUPPORTED OPTICS

100 Base SFP Optics
1000 Base-X SFP
10/100/1000 Base-T SFP
10G-Base-X-SF
40GE QSFP+ Optics
40GE QSFP+ Passive Copper Cables
40GE QSFP+ Active Optical Cables
40GE QSFP+ Fanout Cables
### Ordering Information

<table>
<thead>
<tr>
<th>PART NUMBER</th>
<th>PRODUCT NAME</th>
<th>DESCRIPTION</th>
<th>MAX PER</th>
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</thead>
<tbody>
<tr>
<td><strong>BASE PRODUCTS</strong></td>
<td></td>
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<tr>
<td>48001</td>
<td>BDX8-AC</td>
<td>BlackDiamond X8 Series chassis with 8 I/O slots. Chassis includes 5 Fan Trays. Power Supplies or Blank Panels are not included</td>
<td>1</td>
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<tr>
<td><strong>BASE MODULE OPTIONS</strong></td>
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<tr>
<td>48021</td>
<td>BDX-MM1</td>
<td>Management Module 1 for BlackDiamond X series chassis. 2 modules required for 1+1 redundancy</td>
<td>2</td>
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<tr>
<td>48032</td>
<td>BDXA-FM10T</td>
<td>2.56Tbps Fabric Module for BlackDiamond X chassis. Minimum 3 modules required for wirespeed performance, 4 required for N+1 redundancy supporting full 10Tbps</td>
<td>4</td>
</tr>
<tr>
<td>48031</td>
<td>BDXA-FM20T</td>
<td>5.12Tbps Fabric Module for BlackDiamond X chassis. Minimum 3 modules required for wirespeed performance, 4 required for N+1 redundancy supporting full 20Tbps</td>
<td>4</td>
</tr>
<tr>
<td><strong>I/O MODULE OPTIONS</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>48038</td>
<td>BDXA-G48T</td>
<td>48-Port 1GBASE-T RJ45 module for BlackDiamond X series chassis. Up to 8 modules in the BlackDiamond X8 chassis support up to 384 wirespeed 100/1000MbE (1GbE) copper ports and work with either 2.56 or 5.12Tbps Fabric Modules</td>
<td>8</td>
</tr>
<tr>
<td>48039</td>
<td>BDXA-G48X</td>
<td>48-Port 1GBASE-X SFP module for BlackDiamond X series chassis. Up to 8 modules in the BlackDiamond X8 chassis support up to 384 wirespeed 1GbE ports and work with either 2.56 or 5.12Tbps Fabric Modules. Optics and cables are not included</td>
<td>8</td>
</tr>
<tr>
<td>48040</td>
<td>BDXA-10G48T</td>
<td>48-Port 10GBASE-T RJ45 module for BlackDiamond X series chassis. Up to 8 modules in the BlackDiamond X8 chassis support up to 384 wirespeed 100/1000/10000MbE (10GbE) copper ports and work with either 2.56 or 5.12Tbps Fabric Modules</td>
<td>8</td>
</tr>
<tr>
<td>48041</td>
<td>BDXA-10G48X</td>
<td>48-Port 10GBASE-X SFP+ module for BlackDiamond X series chassis. Up to 8 modules in the BlackDiamond X8 chassis support up to 384 wirespeed 10GbE ports and work with either 2.56 or 5.12Tbps Fabric Modules. Optics and cables are not included</td>
<td>8</td>
</tr>
<tr>
<td>48046</td>
<td>BDXA-40G12X</td>
<td>12-Port 40GBASE-X QSFP+ module for BlackDiamond X series chassis. Up to 8 modules in the BlackDiamond X8 chassis support up to 96 wirespeed 40GbE or 384 wirespeed 10GbE ports and work with either 2.56 or 5.12Tbps Fabric Modules. Optics and cables are not included</td>
<td>8</td>
</tr>
<tr>
<td>48047</td>
<td>BDXB-40G12X-XL</td>
<td>12-Port 40GBASE-X QSFP+ (or used as 48-Port 10GBASE-X SFP+) “XL” module for BlackDiamond X series chassis for up to ~1 Million TCAM entries scale. Up to 8 modules in the BDX8 chassis support up to 96 wirespeed 40GbE or 384 wirespeed 10GbE ports and work with either 2.56 or 5.12Tbps Fabric Modules. Optics and cables are not included</td>
<td>8</td>
</tr>
<tr>
<td>48051</td>
<td>BDXA-40G24X</td>
<td>24-Port 40GBASE-X QSFP+ module for BlackDiamond X series chassis. Up to 8 modules in the BDX8 chassis support up to 192 wirespeed 40GbE or 768 wirespeed 10GbE ports and work with either 2.56 or 5.12Tbps Fabric Module. Optics and cables are not included</td>
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<tr>
<td>48061</td>
<td>BDXB-100G4X</td>
<td>4-Port 100GBASE-X CFP2 module for BlackDiamond X series chassis. Up to 8 modules in the BDX8 chassis support up to 32 wirespeed 100GbE or 320 wirespeed 10GbE ports and work with either 2.56 or 5.12Tbps Fabric Modules. Optics and cables are not included</td>
<td>8</td>
</tr>
<tr>
<td>48062</td>
<td>BDXB-100G4X-XL</td>
<td>4-Port 100GBASE-X CFP2 (or used as 40-Port 10GBASE-X SFP+) “XL” module for BlackDiamond X series chassis for up to ~1 Million TCAM entries scale. Up to 8 modules in the BDX8 chassis support up to 32 wirespeed 100GbE or 320 wirespeed 10GbE ports and work with either 2.56 or 5.12Tbps Fabric Modules. Optics and cables are not included</td>
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<tr>
<td><strong>ACCESSORIES, POWER SUPPLIES AND FAN (SPARE)</strong></td>
<td></td>
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<tr>
<td>48015</td>
<td>BDX8-FAN</td>
<td>Fan Tray for BlackDiamond X8 chassis, spare. 5 fan trays required in the system</td>
<td>5</td>
</tr>
<tr>
<td>48011</td>
<td>BDX-PSU-AC2500</td>
<td>2500W AC Power Supply for BlackDiamond X series chassis. Up to 8 supported in the BDX8 chassis</td>
<td>8</td>
</tr>
<tr>
<td>48018</td>
<td>BDX-I0-BLANK-E</td>
<td>Enhanced Blank Panel for BlackDiamond X series chassis for empty I/O module slot</td>
<td>8</td>
</tr>
<tr>
<td>48020</td>
<td>BDX8-MMK</td>
<td>Mid Mount Kit for BlackDiamond X8 chassis</td>
<td>1</td>
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<tr>
<td><strong>SOFTWARE LICENSES</strong></td>
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<tr>
<td>48094</td>
<td>BDX-CORE-LIC</td>
<td>Core license for the BlackDiamond X8 chassis for scalable Layer 3 rich applications &amp; OpenFlow Feature Pack.</td>
<td>1</td>
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<tr>
<td>48093</td>
<td>BDX-MPLS-LIC</td>
<td>MPLS Feature Pack license for the BlackDiamond X8 chassis.</td>
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<tr>
<td>11011</td>
<td>BDX Direct Attach</td>
<td>Direct Attach Feature Pack for Summit X450a/X460/X480, X650, X670 and BlackDiamond 8800, X Series.</td>
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</tr>
<tr>
<td><strong>POWER CABLES</strong></td>
<td></td>
<td></td>
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</tr>
<tr>
<td>10081</td>
<td>Pwr Cord, 16A,CEE 7/7,C19</td>
<td>Power Cord, 16A, CEE 7/7, IEC320-C19</td>
<td>8</td>
</tr>
<tr>
<td>10087</td>
<td>Pwr Cord, 13A,BS1363,C19</td>
<td>Power Cord, 13A, BS1363, IEC320-C19</td>
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</tbody>
</table>
Extreme Supported Optics

The BlackDiamond X8 switch supports the optics listed below:

10/100/1000 BASE-T Optics*
1000 BASE-X SFP Optics
10G BASE-X SFP+ Optics
40G BASE-X QSFP+ Optics
100G BASE-X CFP2 Optics

*NOTE: Only 1000MbE speed supported on a 10GbE port in a BlackDiamond X8 chassis using 10/100/1000 BASE-T Transceiver

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